



For High Volume

CX600



The CX machine is a fully automatic inline system that promises high throughput and thus achieves cycle time of less than 20 sec per module. The integrated energy management system incl. standby mode ensures low energy consumption. Since oxygen-free soldering with this machine can be done without any additional use of nitrogen, you save yourself the associated costs. A further advantage of the CX system is the integrated profile recording as well as the repeatability of the processes by temperature-controlled profiles. The intuitive touch-screen display provides a simple programming of the system. Three separate, internal process chambers with automatic locks ensure lowest medium consumption.

- √ Automatic loading and unloading of the carriers
- $\sqrt{2}$ carriers multi line for 4 lines with the middle support
- √SMEMA-Interface
- $\sqrt{\,}$ Syncro Mode for repeatable process cycles
- √ SVTC Soft Vapor Temperature Control
- √ Pilot-Mode
- √ Integrated measurements channel
- √ Observation window to process chamber
- √ Heating control system
- √ Automatic medium level system
- √ Automatic medium filtering
- √ Medium recovery system
- √ Production status indicator lightpost
- √ Maintenance free transport system
- √ Operation of integrated PC with TFT-Panel





- 2 additional channels for thermocouple measurement (NiCrNi)
- Siemens-Interfrace
- Cooling device (chiller)
- Batch carrier for manual operation
- VP-measuring electronics and software PTP
- Additional multi line carrier for 4 lines with middle support
- UPS (uninterrupted power supply)
- Trafo for 480V or 208V 3 phase



For High Volume

CX600

Technical Data	CX600	
Length	5.950 mm (inkl. Loading conveyor)	
Depth	1.980 mm	
Height	1.500 mm	
Weight	1980 kg	
Loading/unloading level, approx.	870 / 950 mm (variable)	
Max. board size (manual loading / Batch)	680 x 646 x 65 mm	
Max. board size (Inline)	680 x 305 x 45 mm	
Medium agent filling	40 kg	
Water connection	1/2" / 2,5-5 bar / 3,0l/min	
Max. heating capacity of Vapor Phase heater	6,4 kW	
Ø Energy consumptio/h	3,4 kW	
Power supply	400/230 VAC, 50/60Hz, 6,8kW	
Main fuse	20A, Typ "gL" oder "C"	

⁻ Technical changes reserved -

SOFT VAPOR TEMPERATURE CONTROL (SVTC) AND PILOT-MODE

Wide range of easy-to-program, repeatable temperature profiles



Profiles can be monitored, recorded and reproduced independent of external influence such as loading conditions



Integrated real-time board temperature profiling



Combines the patented SVP-Mode with a precise and repeatable temperature control for different PCBA package sizes and mass requirements



SVTC-Mode controls the temperature gradients by bringing the boards into predefined steps within the vapor phase



Pilot-Mode enables reproduction of any specific solder profile for an assembly immediately



For High Volume

CX800



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- Trafo for 480V or 208V 3 phase



For High Volume

CX800

Technical Data	CX600	
Length	5.950 mm (incl. Loading conveyor)	
Depth	2.390 mm	
Height	1.500 mm	
Weight	2090 kg	
Loading/unloading level, approx.	870 / 950 mm (variable)	
Max. board size (manual loading / Batch)	826 x 680 x 65 mm	
Max. board size (Inline)	680 x 510 x 45 mm	
Medium agent filling	45 kg	
Water connection	1/2" / 2,5-5 bar / 6,0l/min	
Max. heating capacity of Vapor Phase heater	10,4 kW	
Ø Energy consumptio/h	5,3 kW	
Power supply	400/230 VAC, 50/60Hz, 10,7kW (16,0 kw)	
Main fuse	32A, Typ "gL" or "C"	

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